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(Use several sheets if necessary)		Darin P. Smedberg	
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 U.S. PTO
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U.S. Patent Documents

*Examiner Initial		Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate
BA	AA	4,377,320	Mar. 22, 1983	Lathrop et al.	439 339	578 177 R	
	AB	4,412,717	Nov. 1, 1983	Monroe	439 339	578 177 R	
	AC	4,655,534	Apr. 7, 1987	Stursa	439 339	578 177 R	
	AD	6,036,540	Mar. 14, 2000	Beloritsky	439	582	

Foreign Patent Documents

							Translation	
		Document	Date	Country	Class	Subclass	Yes	No
	AE							

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

BA	AF	"Trompeter", downloaded 11/16/2001 from < http://www.trompeter.com/shop/ProductDetail.asp?ProdStock=UPLFF220%2 >, Trompeter Electronics, Inc. (2001).
	AG	Diagram, Trompeter Electronics, Inc.
	AH	"Interface Dimensions MIL-STD-348" AEP, Page 60.
	AI	"Cable Plugs Straight and Right Angle" AEP.
	AJ	"SMB Connectors", downloaded 9/28/2001 from < http://www.molex.com/product/rf/smb.html >, Molex Incorporated (2000).
	AK	"Coaxial Assemblies for DS-3 Interconnections" LoDan International Offices (November 2000).
	AL	"Amphenol RF Connectors", downloaded 10/29/2001 from < http://www.sescodatasystems.com/amphenol_rf_connectors.htm >, SESCO Data Systems.
	AM	"250 Series Mini-BNC (M-BNC)" Trompeter Electronics.
	AN	"Copper Assemblies", downloaded 10/29/2001 from < http://www.csp.com/html/cp_products/copper_assemblies.html >, Computer Systems Products, Inc. (2001).
	AO	"Amphenol SMB/SMC Connectors", downloaded 10/29/2001 from < http://www.sescodatasystems.com/amphenol/smb_smc.html >, SESCO Data Systems.

Examiner Brigitte Hennrich Date Considered 3-3-03

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